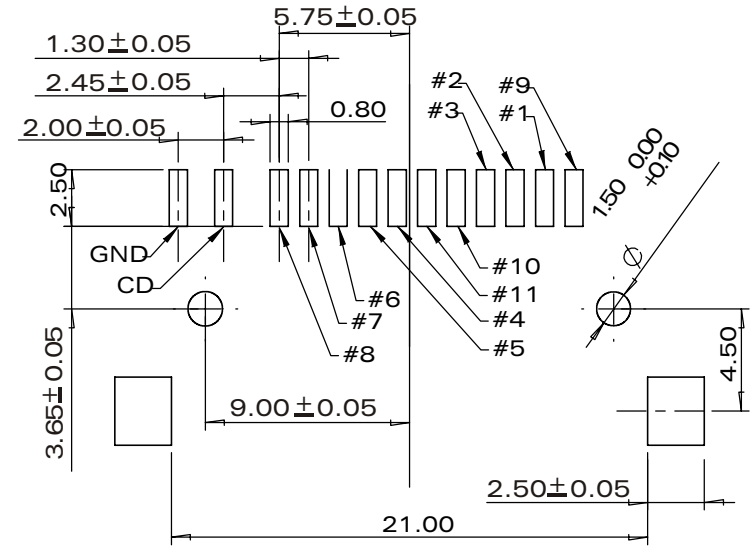


NOTES:  
 1. MATERIAL:  
 INSULATOR: HIGH TEMPERATURE THERMOPLASTIC,  
 UL94V-0, BLACK  
 CONTACT: PHOSPHOR BRONZE  
 2. CONTACT AREA PLATING: 10u GOLD OVER 50u NI



PCB LAYOUT



**MORETHANALL**  
 CONNECTORS  
 ASSEMBLIES

PART NO. **MSDC-W18X-11**

DWG NO. **MSDC-W18X-11**

CHECKED BY CY

TOLERANCES ARE

DESCRIPTION: **MINI SD CONNECTOR**

FILE NO.

DRAWING BY

.X ± 0.3  
 .XX ± 0.2  
 .XXX ±  
 AWG

AREA

REVISIONS

HK

DATE

**煜倫有限公司**

UNIT / mm

SCALE 1:1

PROJECTION

